



A Product Line of Diodes Incorporated



DMN3024LSS

30V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D T _A = 25°C		
30V	24mΩ @ V _{GS} = 10V	8.5A		
	36mΩ @ V _{GS} = 4.5V	6.9A		

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- Backlighting
- DC-DC Converters
- Power management functions

Features and Benefits

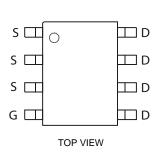
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)

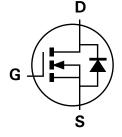
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)



TOP VIEW





Equivalent Circuit

Ordering Information (Note 1)

Product	Product Marking		Tape width (mm)	Quantity per reel	
DMN3024LSS-13	N3024LS	13	12	2,500	

Note: 1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

Marking Information



N3024LS = Product Type Marking Code D11 = Manufacturer's Marking YY WW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01-52)



DMN3024LSS

Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic			Symbol	Value	Unit
Drain-Source voltage			V _{DSS}	30	V
Gate-Source voltage			V _{GS}	±20	V
		(Note 3)		8.5	
Continuous Drain current	$V_{GS} = 10V$	$T_{A} = 70^{\circ}C$ (Note 3)	-	6.8	А
		(Note 2)		6.4	
Pulsed Drain current	V _{GS} = 10V	(Note 4)	I _{DM}	36	А
Continuous Source current (Body diode) (Note 3)		(Note 3)	Is	4.5	А
Pulsed Source current (Body diode) (Note 4)		(Note 4)	I _{SM}	36	А

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Power dissipation	(Note 2)		1.6 12.5	W	
Linear derating factor	(Note 3)	PD	2.8 22.2	mW/°C	
Thermal Resistance, Junction to Ambient	(Note 2) (Note 3)	$R_{ ext{ heta}}JA$	<u>80</u> 45	°C/W	
Thermal Resistance, Junction to Lead	(Note 5)	$R_{ ext{ heta}JL}$	35	°C/W	
Operating and storage temperature range		TJ, TSTG	-55 to 150	۵°	

Notes: 2. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

3. Same as note (2), except the device is measured at t \leq 10 sec.

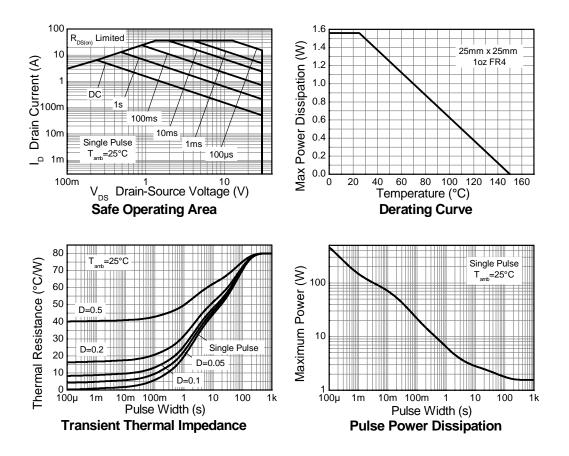
4. Same as note (2), except the device is pulsed with D= 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.

5. Thermal resistance from junction to solder-point (at the end of the drain lead): the device is operating in a steady-state condition.





Thermal Characteristics





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Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS				•	•	
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μΑ	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	1.0	_	3.0	V	I _D = 250μA, V _{DS} = V _{GS}
Static Drain-Source On-Resistance (Note 6)	Р	_		0.024	Ω	V _{GS} = 10V, I _D = 7.0A
Static Drain-Source On-Resistance (Note 6)	R _{DS (ON)}		_	0.036	12	V _{GS} = 4.5V, I _D = 6.0A
Forward Transconductance (Notes 6 & 7)	g fs	_	16.5	_	S	V _{DS} = 15V, I _D = 7.1A
Diode Forward Voltage (Note 6)	V _{SD}		0.82	1.2	V	I _S = 1.7A, V _{GS} = 0V
Reverse recovery time (Note 7)	t _{rr}		12	—	ns	
Reverse recovery charge (Note 7)	Q _{rr}	_	4.8	_	nC	-I _S = 2.2A, di/dt= 100A/μs
DYNAMIC CHARACTERISTICS (Note 7)	· · · ·					·
Input Capacitance	C _{iss}	_	608	_	pF	
Output Capacitance	C _{oss}	_	132	_	pF	└──V _{DS} = 15V, V _{GS} = 0V - f= 1MHz
Reverse Transfer Capacitance	C _{rss}	_	71	_	pF	
Total Gate Charge	Qg	_	6.3	_	nC	V _{DS} = 15V, V _{GS} = 4.5V I _D = 7A
Total Gate Charge	Qg	_	12.9	_	nC	
Gate-Source Charge	Q _{gs}	_	2.5	_	nC	V _{DS} = 15V, V _{GS} = 10V
Gate-Drain Charge	Q _{gd}	_	2.5	—	nC	$-I_{D}=7A$
Turn-On Delay Time (Note 8)	t _{D(on)}	_	2.9	_	ns	
Turn-On Rise Time (Note 8)	tr	_	3.3	_	ns	V _{DD} = 15V, V _{GS} = 10V
Turn-Off Delay Time (Note 8)	t _{D(off)}	_	16	_	ns	I _D = 1A, R _G ≅ 6.0Ω
Turn-Off Fall Time (Note 8)	t _f	_	8	_	ns	1

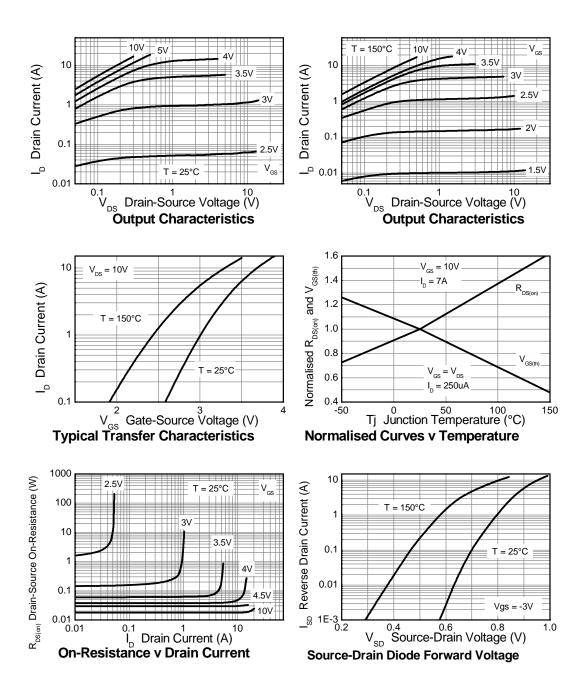
6. Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$ Notes:

For design aid only, not subject to production testing.
Switching characteristics are independent of operating junction temperatures.



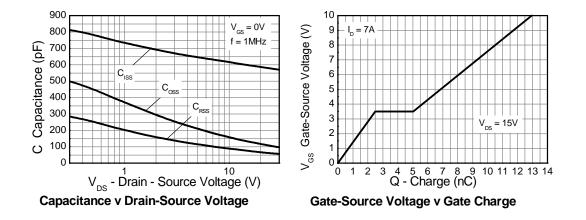


Typical Characteristics





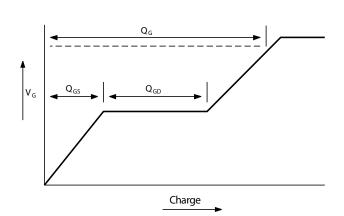
Typical Characteristics - continued



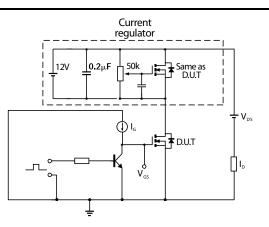
Test Circuits

V_{DS} 90%

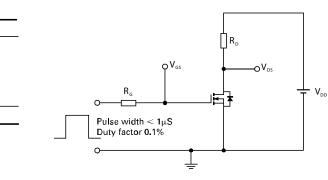
10% V_{GS}



Basic gate charge waveform



Gate charge test circuit



Switching time waveforms

t_{d(off)}

t_r

t_(on)

Switching time test circuit

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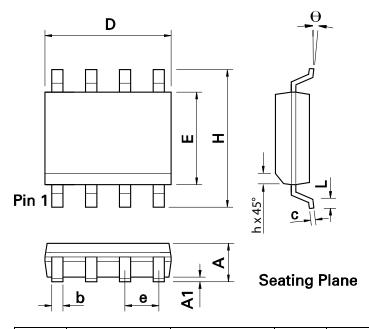
t_{d(on)}

t_r

t_(on)

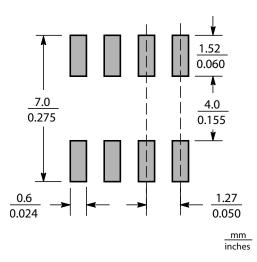


Package Outline Dimensions



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
А	0.053	0.069	1.35	1.75	е	0.050 BSC		1.27 BSC	
A1	0.004	0.010	0.10	0.25	b	0.013	0.020	0.33	0.51
D	0.189	0.197	4.80	5.00	С	0.008	0.010	0.19	0.25
Н	0.228	0.244	5.80	6.20	θ	0°	8°	0°	8°
E	0.150	0.157	3.80	4.00	h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27	-	-	-	-	-

Suggested Pad Layout





DMN3024LSS

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